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IEEE TRANSACTIONS ON INDUSTRIAL ELECTRONICS

Editor-in-Chief

MARIAN P. KAZMIERKOWSKI, *Professor*
Institute of Control and Industrial Electronics
Warsaw University of Technology
ul. Koszykowa 75 g.E Warsaw 00-662, Poland
phone: +48 22 628 0665 fax: +48 22 625 6633
e-mail: ie.editor@ee.pw.edu.pl

Associate Editors

Power Electronics

J. BALCELLS
Tech. Univ. of Catalonia
balcells@eel.upc.es
G. A. CAPOLINO
Univ. of Picardie Jules Verne
gerard.capolino@sc.u-picardie.fr
J. C. CLARE
The Univ. of Nottingham
Jon.Clare@nottingham.ac.uk
A. EMADI
Illinois Inst. of Technol.
emadi@iit.edu
G. GARCERA
Univ. Politcnica de Valencia
ggarcera@eln.upv.es
L. M. GRZESIAK
Warsaw Univ. of Technol.
lmg@isep.pw.edu.pl
J. M. GUERRERO
Tech. Univ. of Catalonia
josep.m.guerrero@upc.es
S. HALASZ
Budapest Univ. of Technol.
and Economics
shalasz@eik.bme.hu
Y. HORI
Univ. of Tokyo
hori@iis.u-tokyo.ac.jp
M. ISHIDA
Mie Univ
ishida@elec.mie-u.ac.jp
F. S. KANG
Hanabat Nat. Univ.
feelsoon@hanabat.ac.kr

M. K. KAZMIERCZUK
Wright State Univ.
mkazim@cs.wright.edu
B. R. LIN
Nat. Yunlin Univ. of Sci. and Technol.
linbr@pine.yuntech.edu.tw
F. L. LUO
Nanyang Technological Univ.
efluo@ntu.edu.sg
S. K. MAZUMDER
Univ. of Illinois
mazumder@ece.uic.edu
T. OHNISHI
The Univ. of Tokushima
ohnishi@ee.tokushima-u.ac.jp
J. RODRIGUEZ
Tech. Univ. Federico Santa Maria
jrp@elo.utfsm.cl
F. A. SILVA
Tech. Univ. of Lisbon
fernandos@alfa.ist.utl.pt
B. M. WILAMOWSKI
Auburn Univ.
wilam@ieee.org
A. F. ZOBAA
Cairo Univ.
a.zobaa@eng.cu.edu.eg

Drive Control

G. M. ASHER
Univ. of Nottingham
greg.asher@nottingham.ac.uk
C. CECATI
Univ. Degli Studi Di L'Aquila
c.cecati@ieee.org
R. DHAOUADI
American Univ. of Sharjah
rdhaouadi@ausharjah.edu

L. HARNEFORS
Mälardalen Univ.
lennart.harnefors@mdh.se

J. HOLTZ
Wuppertal Univ.
j.holtz@ieee.org

A. M. KHAMBADKONE
Nat. Univ. of Singapore
eleamk@nus.edu.sg

E. LEVI
Liverpool John
Moore's Univ.
e.levi@livjm.ac.uk

T. H. LIU
Nat. Taiwan Univ. of Sci.
and Technol.
Liu@mail.ntust.edu.tw

T. S. LOW
Republic Politechnic
Tanglin Campus
tslow@rp.edu.sg

G. D. MARQUES
Inst. Superior Tecnico
gil.marques@ist.utl.pt

N. MATSUI
Nagoya Inst. of Technol.
matsui@nitech.ac.jp

N. MUTOH
Tokyo Metropolitan
Inst. of Technol.
nmutoh@cc.tmit.ac.jp

A. M. TRZYNADLOWSKI
Univ. of Nevada
chin@moriah.unr.edu

Newsletter Editor
A. MALINOWSKI
Bradley Univ.

Robotics and Vision

F. ASHRAFAZADEH
Whirlpool Inc.
farhad_ashrafzadeh@whirlpool.com
H. S. CHO
Korea Advanced Inst. of Sci. and Technol.
hscho@lca.kaist.ac.kr
R. C. LUO
Nat. Chung Cheng Univ.
luo@ia.ee.ccu.edu.tw
K. OHISHI
Nagaoka Univ. of Technol.
ohishi@vos.nagaokaut.ac.jp
K. OHNISHI
Keio Univ.
k.ohnishi@ieee.org
CH. PARK
Kyung Hee Univ.
ckpark@khu.ac.kr
W. L. XU
Massey Univ.
w.l.xu@massey.ac.nz

Signal Processing and Control

J. A. DE ABREU-GARCIA
Univ. of Akron
alexis4@uakron.edu
J. Y. HUNG
Auburn Univ.
jhung@eng.auburn.edu
K. ICHIGE
Yokohama Nat. Univ.
koichi@ynu.ac.jp
M. H. LEE
Pusan Nat. Univ.
mahlee@hyowon.ac.kr
T. H. LEE
The Nat. Univ. of Singapore
eleleeth@nus.edu.sg

S. WON
Pohang Univ. of Sci. and Technol.
won@postech.ac.kr

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M. Y. CHOW
North Carolina State Univ.
chow@eos.ncsu.edu
M. N. CIRSTEIA
Univ. of Technol.
m.cirstea@apu.ac.uk
T. FURUHASHI
Mie Univ.
furuhashi@pa.info.mie-u.ac.jp
D. HISSEL
UTBM
daniel.hissel@ieee.org
A. S. HODEL
Auburn Univ.
a.s.hodel@eng.auburn.edu
O. KAYNAK
Bogazici Univ.
kaynak@boun.edu.tr
K. F. MAN
City Univ. of Hong Kong
k.man@ieee.org
T. ORLOWSKA-KOWALSKA
Wroclaw Univ. of Technol.
tok@imne.pwr.wroc.pl
I. J. RUDAS
Budapest Polytechnic
rudas@bmf.hu
T. YAMAGUCHI
Tokyo Metropolitan Inst. of Technol.
yamachan@fml.ec.tmit.ac.jp

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